

### Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

### **Quality Overview**

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.



### **General Description**

The MAX4514/MAX4515 are single-pole/single-throw (SPST), CMOS, low-voltage, single-supply analog switches with very low switch on-resistance. The MAX4514 is normally open (NO). The MAX4515 is normally closed (NC).

These CMOS switches can operate continuously with a single supply between +2V and +12V. Each switch can handle rail-to-rail analog signals. The off-leakage current maximum is only 1nA at +25°C or 20nA at +85°C.

All digital inputs have 0.8V to 2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility when using a +5V supply.

For pin-compatible parts for use with dual supplies, see the MAX4516/MAX4517.

### **Applications**

Battery-Operated Equipment

Audio and Video Signal Routing

Low-Voltage Data-Acquisition Systems

Communications Circuits

**PCMCIA Cards** 

Cellular Phones

Modems

#### **Features**

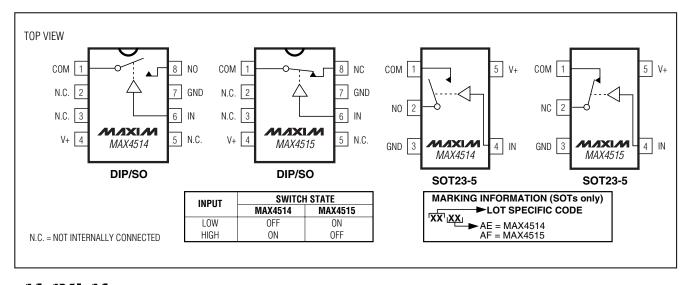
- ♦ Available in SOT23-5 Package
- ♦ +2V to +12V Single-Supply Operation
- **♦** Guaranteed On-Resistance: 20 $\Omega$  with +5V Supply 10 $\Omega$  with +12V Supply
- **♦ Guaranteed Low Off-Leakage Currents:** 1nA at +25°C 20nA at +85°C
- **♦** Guaranteed Low On-Leakage Currents: 2nA at +25°C 40nA at +85°C
- ♦ Low Charge Injection: 10pC
- ♦ Fast Switching Speed: toN = 150ns, toFF = 100ns
- ♦ Break-Before-Make Operation: toN > toFF at +5V
- **♦ TTL/CMOS-Logic Compatible with +5V Supply**

#### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX4514CPA	0°C to +70°C	8 Plastic DIP
MAX4514CSA	0°C to +70°C	8 SO
MAX4514CUK	0°C to +70°C	5 SOT23-5
MAX4514C/D	0°C to +70°C	Dice*

Ordering Information continued at end of data sheet.

### **Pin Configurations**



MIXIM

Maxim Integrated Products 1

<sup>\*</sup>Contact factory for dice specifications.

#### **ABSOLUTE MAXIMUM RATINGS**

(Voltages referenced to GND.) V+0.3V, +1	3V
Voltage into Any Terminal (Note 1)0.3V to (V+ + 0.4	
or ±20mA (whichever occurs fir	st)
Continuous Current into Any Terminal±20	'nΑ
Peak Current, NO_ or COM_	
(pulsed at 1ms,10% duty cycle)±30	
ESD per Method 3015.7>200	)OV
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	
8-Pin Plastic DIP (derate 9.09mW/°C above +70°C)727r 8-Pin SO (derate 5.88mW/°C above +70°C)471r	

5-Pin SOT23-5 (derate 7.1mW/°C a	above +70°C)571mW
8-Pin CERDIP (derate 8.00mW/°C	above +70°C)640mW
Operating Temperature Ranges	
MAX4514C/MAX4515C	0°C to +70°C
MAX4514E/MAX4515E	40°C to +85°C
MAX4514MJA/MAX4515MJA	55°C to +125°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Note 1: Voltages exceeding V+ or GND on any signal terminal are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS—+5V Supply**

(V+ = +4.5V to +5.5V, VINH = 2.4V, VINL = 0.8V, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP (Note 2	MAX )	UNITS
ANALOG SWITCH								
Analog Signal Range	V <sub>COM</sub> , V <sub>NO</sub> , V <sub>NC</sub>				0		V+	V
COM to NO or NC On-Resistance	R <sub>ON</sub>	V+ = 5V, V <sub>COM</sub> = 3.5V, I <sub>COM</sub> = 1mA	$T_A = +25$ °C $T_A = T_{MIN}$ to	T <sub>MAX</sub>		10	20 25	Ω
COM to NO or NC On-Resistance Flatness	ΔRon	V <sub>COM</sub> = 1V, 2V, 3V; I <sub>COM</sub> = 1mA	$T_A = +25^{\circ}C$ $T_A = T_{MIN}$ to	TMAX		1	3	Ω
NO or NO Off Lookaga	luc (OFF)	V+ = 5.5V,	T <sub>A</sub> = +25°C	111111111111111111111111111111111111111	-1	0.01	1	
NO or NC Off-Leakage Current (Note 3)	INO(OFF) INC(OFF)	$V_{COM} = 1V,$ $V_{NO}$ or $V_{NC} = 4.5V$	$T_A = T_{MIN}$	C, E	-20		20	nA
		V+ = 5.5V, VCOM = 4.5V, VNO or VNC = 1V	to $T_{MAX}$ $T_{A} = +25^{\circ}C$	М	-100 -1	0.01	100	
COM Off-Leakage Current (Note 3)	ICOM(OFF)		$T_A = T_{MIN}$	C, E	-20	0.01	20	nA
			to TMAX	М	-100		100	
COM On-Leakage Current	ICOM(ON)	V+ = 5.5V, V <sub>COM</sub> = 4.5V, V <sub>NO</sub> or V <sub>NC</sub> = 4.5V	T <sub>A</sub> = +25°C	1 -	-2	0.01	2	
(Note 3)			$T_A = T_{MIN}$ to $T_{MAX}$	C, E	-40 -200		40 200	nA
DIGITAL I/O				1				
Input Logic High	VIH				2.4		V+	V
Input Logic Low	V <sub>IL</sub>				0		0.8	V
Input Current Logic High or Low	lih, lil	VIN = V+, OV			-1	0.03	1	μА
SWITCH DYNAMIC CHA	RACTERIST	ics						
Turn-On Time	ton	Figure 2	$T_A = +25^{\circ}C$ $T_A = T_{MIN} \text{ to } T_{MAX}$			30	150	ns
	-014	J. 7 _					240	
Turn-Off Time	toff	   Figure 2	T <sub>A</sub> = +25°C			20	100	- ns
	-		TA = TMIN to TMAX				150	

### **ELECTRICAL CHARACTERISTICS—+5V Supply (continued)**

 $(V+ = +4.5V \text{ to } +5.5V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_A = +25^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS			TYP (Note 2)	MAX	UNITS
SWITCH DYNAMIC CHARA	CTERISTICS						
Charge Injection (Note 4)	Q	$C_L = 1$ nF, $V_{NO} = 0$ V, R <sub>S</sub> = $0\Omega$ , T <sub>A</sub> = +25°C, Figure 1			2	10	рС
Off Isolation	V <sub>ISO</sub>	$R_L = 50\Omega$ , $C_L = 15pF$ , $V_{NO} = 1V_{RMS}$ , $f = 100kHz$ , $T_A = +25^{\circ}C$ , Figure 3			≤-90		dB
NO or NC Off Capacitance	C <sub>NO(OFF)</sub> , C <sub>NC(OFF)</sub>	f = 1MHz, TA = +25°C, Figure 4			14		pF
COM Off Capacitance	CCOM(OFF)	f = 1MHz, T <sub>A</sub> = +25°C, Figure 4			14		pF
COM On Capacitance	C <sub>COM</sub> (ON)	f = 1MHz, T <sub>A</sub> = +25°C, Figure 4			30		pF
POWER SUPPLY							•
V+ Supply Current	l+	V <sub>IN</sub> = 0V or V+	$T_A = +25$ °C $T_A = T_{MIN}$ to $T_{MAX}$	-1 -10		1 10	μА

### **ELECTRICAL CHARACTERISTICS—+12V Supply**

 $(V+=+11.4V\ to\ +12.6V,\ V_{INH}=5V,\ V_{INL}=0.8V,\ T_A=T_{MIN}\ to\ T_{MAX},\ unless\ otherwise\ noted.\ Typical\ values\ are\ at\ T_A=+25^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS				TYP (Note 2)	MAX )	UNITS
ANALOG SWITCH								
Analog Signal Range	VCOM, VNO, VNC				0		V+	V
COM to NO or NC On-Resistance	Ron	V <sub>COM</sub> = 10V, I <sub>COM</sub> = 1mA	$T_A = +25^{\circ}C$ $T_A = T_{MIN}$ to	T <sub>MAX</sub>		5	10 15	Ω
NO NO OU I		10.00/.0/	T <sub>A</sub> = +25°C		-2		2	
NO, NC Off-Leakage Current (Note 3)	I(NO)OFF I(NC)OFF	$V + = 12.6V, V_{COM} = 1V,$ $V_{NO} \text{ or } V_{NC} = 10V$	TA = TMIN	C, E	-50		50	nA
our one (Note o)	I(NC)OFF	1/10 or 1/10 = 101	to T <sub>MAX</sub>	М	-200		200	
COM Off Leakers Comment	ICOM(OFF)	V+ = 12.6V, V <sub>COM</sub> = 10V, V <sub>NO</sub> or V <sub>NC</sub> = 1V	T <sub>A</sub> = +25°C		-2		2	
COM Off-Leakage Current (Note 3)			T <sub>A</sub> = T <sub>MIN</sub>	C, E	-50		50	nA
(14010-0)			to T <sub>MAX</sub>	М	-200		200	]
0014 0 - 1 - 1 0 1	ICOM(ON)	V+ = 12.6V, V <sub>COM</sub> = 10V, V <sub>NO</sub> or V <sub>NC</sub> = 10V	T <sub>A</sub> = +25°C		-4		4	
COM On-Leakage Current (Note 3)			TA = TMIN	C, E	-100		100	nA
(11010 0)			to T <sub>MAX</sub>	М	-400		400	1
DIGITAL I/O				•	•			
Input Logic High	VINH				5		V+	V
Input Logic Low	VINL						0.8	V
Input Current Logic High or Low	linh, linl	V <sub>IN</sub> = V+, 0V			-1	0.03	1	μΑ
POWER SUPPLY					•			·
V. Supply Current	l+	IN = 0V or V+	$T_A = +25^{\circ}C$ $T_A = T_{MIN}$ to $T_{MAX}$		-2		2	
V+ Supply Current	1+	IIN = UV UI V+			-20		20	μΑ

### **ELECTRICAL CHARACTERISTICS—+3V Supply**

 $(V+ = +3V \text{ to } +3.6V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_A = +25^{\circ}\text{C.})$ 

PARAMETER	SYMBOL	CONDITIONS			TYP (Note 2	MAX )	UNITS	
ANALOG SWITCH		I						
Analog Signal Range	V <sub>COM</sub> , V <sub>NO</sub> , V <sub>NC</sub>			0		V+	V	
COM to NO or NC	Ron	VCOM = 1.5V, INO = 1mA,	T <sub>A</sub> = +25°C		20	50	Ω	
On-Resistance	TION	V+ = 3V	$T_A = T_{MIN}$ to $T_{MAX}$			75	32	
DIGITAL I/O								
Input Logic High	VINH			2.4		V+	V	
Input Logic Low	V <sub>INL</sub>			0		0.80	V	
Input Current Logic High or Low	I <sub>INH</sub> , I <sub>INL</sub>	V <sub>IN</sub> = V+, 0V		-1	0.03	1	μА	
SWITCH DYNAMIC CHAP	RACTERISTICS			-1			•	
Turn-On Time	ton	Figure 0	T <sub>A</sub> = +25°C		45	150	200	
(Note 4)	ton	Figure 2	TA = TMIN to TMAX			240	– ns	
Turn-Off Time	+0==	Figure 0	T <sub>A</sub> = +25°C		30	100	200	
(Note 4)	tOFF	Figure 2	$T_A = T_{MIN}$ to $T_{MAX}$			150	ns	
Charge Injection (Note 4)	Q	C <sub>L</sub> = 1nF, Figure 1	T <sub>A</sub> = +25°C		4	10	рС	
POWER SUPPLY	1	I	-1				1	
V. Cumply Cumpet	1.	IN 01/ 0 x 1/ .	T <sub>A</sub> = +25°C	-1		1		
V+ Supply Current	I+	IN = 0V  or  V+	T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-10		10	-  μΑ	

Note 2: The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

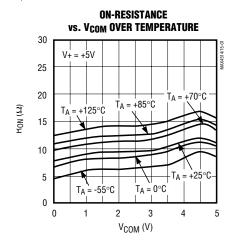
Note 3: Leakage parameters are 100% tested at maximum-rated hot operating temperature, and are guaranteed by correlation at +25°C.

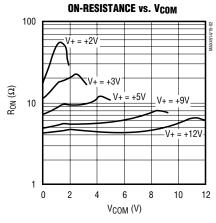
Note 4: Guaranteed, not production tested.

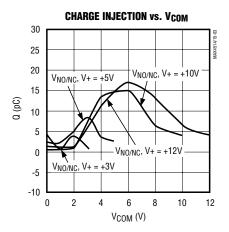
**Note 5:** SOT packaged parts are 100% tested at +25°C. Limits at maximum and minimum rated temperature are guaranteed by design and correlation limits at +25°C.

### Typical Operating Characteristics

 $(V+ = +5V, GND = 0V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

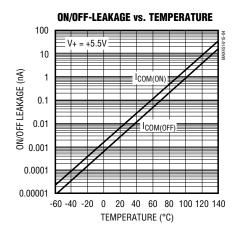


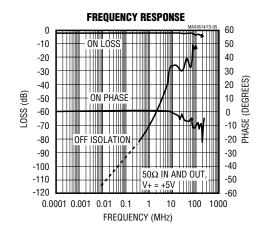




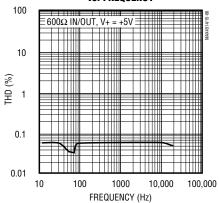
### **Typical Operating Characteristics (continued)**

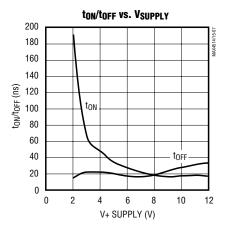
 $(V+ = +5V, GND = 0V, TA = +25^{\circ}C, unless otherwise noted.)$ 











### **Pin Description**

	P	IN				
MAX	MAX4514		MAX4515		FUNCTION	
DIP/SO	SOT23-5	DIP/SO	SOT23-5			
1	1	1	1	COM	Analog Switch Common Terminal	
2, 3, 5	_	2, 3, 5	_	N.C.	No Connection (Not Internally Connected)	
4	5	4	5	V+	Positive Supply-Voltage Input (Analog and Digital)	
6	4	6	4	IN	Digital Control Input	
7	3	7	3	GND	Ground	
8	2	_	_	NO	Analog Switch (Normally Open)	
	_	8	2	NC	Analog Switch (Normally Cosed)	

**Note:** NO, NC, and COM pins are identical and interchangeable. Any may be considered as an input or an output; signals pass equally well in both directions.



### Applications Information

#### Power-Supply Considerations

The MAX4514/MAX4515 construction is typical of most CMOS analog switches, except that they have only two supply pins: V+ and GND. V+ and GND drive the internal CMOS switches and set their analog voltage limits. Reverse ESD-protection diodes are internally connected between each analog-signal pin and both V+ and GND. One of these diodes conducts if any analog signal exceeds V+ or GND.

Virtually all the analog leakage current comes from the ESD diodes to V+ or GND. Although the ESD diodes on a given signal pin are identical and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+ or GND and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the V+ and GND pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity.

There is no connection between the analog-signal paths and V+ or GND.

V+ and GND also power the internal logic and logic-level translators. The logic-level translators convert the logic levels to switched V+ and GND signals to drive the analog signal gates.

#### **Logic-Level Thresholds**

The logic-level thresholds are CMOS/TTL compatible when V+ is +5V. As V+ is raised, the level threshold increases slightly. When V+ reaches +12V, the level threshold is about 3.0V—above the TTL guaranteed high-level minimum of 2.8V, but still compatible with CMOS outputs.

Do not connect the MAX4514/MAX4515's V+ to +3V and then connect the logic-level pins to logic-level signals that operate from +5V supply. Output levels can exceed +3V and violate the absolute maximum ratings, damaging the part and/or external circuits.

#### **High-Frequency Performance**

In  $50\Omega$  systems, signal response is reasonably flat up to 250MHz (see *Typical Operating Characteristics*). Above 20MHz, the on response has several minor peaks that are highly layout dependent. The problem is not in turning the switch on; it's in turning it off. The off-state switch acts like a capacitor and passes higher frequencies with less attenuation. At 10MHz, off isolation is about -45dB in  $50\Omega$  systems, decreasing (approximately 20dB per decade) as frequency increases. Higher circuit impedances also make off isolation decrease. Off isolation is about 3dB above that of a bare IC socket, and is due entirely to capacitive coupling.

### Test Circuits/Timing Diagrams

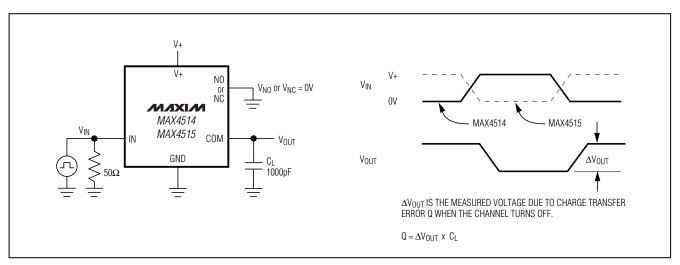


Figure 1. Charge Injection

6 \_\_\_\_\_\_ /I/XI/M

### Test Circuits/Timing Diagrams (continued)

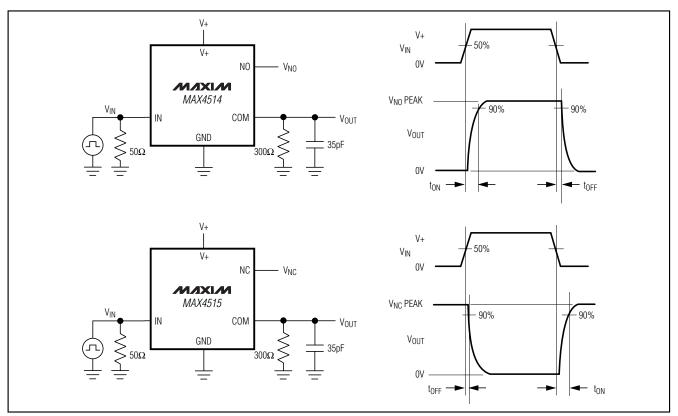


Figure 2. Switching Times

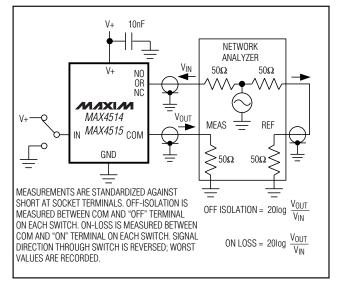


Figure 3. Off-Isolation and On-Loss

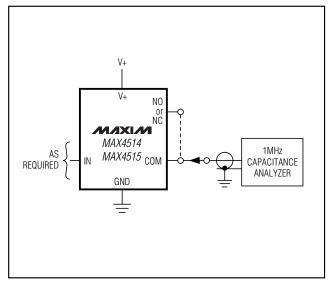


Figure 4. NO, NC, and COM Capacitance

### **Ordering Information (continued)**

PART	TEMP. RANGE	PIN-PACKAGE
MAX4514EPA	-40°C to +85°C	8 Plastic DIP
MAX4514ESA	-40°C to +85°C	8 SO
MAX4514EUK	-40°C to +85°C	5 SOT23-5
MAX4514MJA	-55°C to +125°C	8 CERDIP**
MAX4515CPA	0°C to +70°C	8 Plastic DIP
MAX4515CSA	0°C to +70°C	8 SO
MAX4515CUK	0°C to +70°C	5 SOT23-5
MAX4515C/D	0°C to +70°C	Dice*
MAX4515EPA	-40°C to +85°C	8 Plastic DIP
MAX4515ESA	-40°C to +85°C	8 SO
MAX4515EUK	-40°C to +85°C	5 SOT23-5
MAX4515MJA	-55°C to +125°C	8 CERDIP**

<sup>\*</sup>Contact factory for dice specifications.

# GND IN 0.046" (1.17mm)

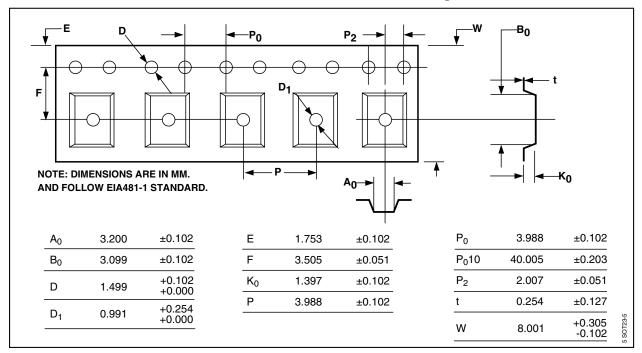
**Chip Topography** 

COM

TRANSISTOR COUNT: 19
SUBSTRATE IS INTERNALLY CONNECTED TO V+

0.031<u>"</u> (0.79mm)

### Tape-and-Reel Information



NO

0R

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

<sup>\*\*</sup>Contact factory for availability.